

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
MAGNUS NAMBORD	08/26/2014
EMIL HANSSON	08/26/2014
RECEIVING PARTY DATA	
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14468911
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ATTORNEY DOCKET NUMBER:	9342-569C / PS14 1107US1
NAME OF SUBMITTER:	SUSAN E. FREEDMAN
SIGNATURE:	/Susan E. Freedman/
DATE SIGNED:	08/26/2014
Total Attachments: 3	
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source=9342-569C_2014-08-26_Assignment#page3.tif	

ASSIGNMENT

THIS ASSIGNMENT, made by us, **Magnus NAMBORD**, citizen of Sweden, having a mailing address of Nya Vattentorget, Visiting Mobilvägen 4, Glasgow, Building B, Floor 3, Lund, Sweden; and **Emil HANSSON**, citizen of Sweden, having a mailing address of Mobilvägen 4, Lund Sweden;

WITNESSETH: That,

WHEREAS, we are joint inventors of certain new and useful improvements in **REMOVABLE CONDUCTIVE LAYER THAT SHIELDS AND/OR SHORTS NODES OF AN NFC CIRCUIT TO CONTROL TRANSMISSIONS THEREFROM**, for which U.S. Patent Application No. 14/468,911 was filed on 08-26-2014 (we hereby authorize and request Myers Bigel Sibley & Sajovec, P.A., to insert the filing date and application number of said application when known or to file this Assignment concurrently with the application); and

WHEREAS, **Sony Corporation**, a corporation organized under the laws of Japan, having a principal place of business at 1-7-1 Konan, Minato-ku, Tokyo, 108-0075 Tokyo, Japan, hereinafter referred to as assignee, is desirous of acquiring my entire right, title and interest in and to said invention as described in said application(s), and in and to any and all Letters Patent which shall be granted therefor in the United States of America and all foreign countries;

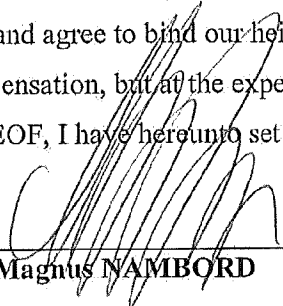
NOW, THEREFORE, To Whom It May Concern, be it known that for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we have sold and by these presents do hereby sell, assign, transfer and convey unto said assignee, its successors and assigns, the entire right, title, and interest in and to the said invention and application(s), and in and to any and all continuations, continuations-in-part, or divisions thereof, and in and to any and all Letters Patent of the United States of America and all foreign countries or reissues or other forms of protection thereof which may be granted therefor or thereon, for the full end of the term for which said Letters Patent may be granted along with any term extensions thereon or therefor, together with the right to claim the priority of said application in all foreign countries in accordance with the International Convention, the same to be held and enjoyed by said assignee, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by us if this assignment and sale had not been made.

We hereby request that said Letters Patent be issued in accordance with this assignment.

We further covenant and agree that, at the time of the execution and delivery of these presents, we possess full title to the invention and applications above-mentioned, and that we have the unencumbered right and authority to make this assignment.

We further covenant and agree to promptly communicate to said assignee or its representatives any facts known to us relating to said invention, to testify in any interference or legal proceedings involving said invention, to execute any additional papers which may be requested to confirm the right of the assignee, its representatives, successors, or assigns to secure patent or similar protection for the said invention in all countries and to vest in the assignee complete title to the said invention and Letters Patent, without further compensation, but at the expense of said assignee, its successors, assigns, and other legal representatives; and we hereby instruct, and further covenant and agree to bind our heirs, legal representatives, and assigns, to do same, without further compensation, but at the expense of said assignee or its representatives.

IN WITNESS WHEREOF, I have hereunto set my hand and seal on this 26 day of August, 2014.

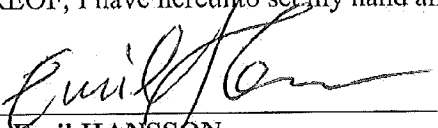


Magnus NAMBORD (SEAL)

Witnessed by:




Date: 26 August 2014

IN WITNESS WHEREOF, I have hereunto set my hand and seal on this 26th day of
August, 2014.


Emil HANSSON (SEAL)

Witnessed by:



Date: 26/8 - 2014